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SMC735

TECHNICAL DATA

Visible LED, SMD

AIGaAs

silicone resin

SMC735 is a AlGaAs LED mounted on a ceramic SMD package and sealed with silicone or epoxy resin for damp proof. On forward bias, it emits a radiation of typical 10 mW at a peak wavelength of 735 nm.

anode mark

Specifications

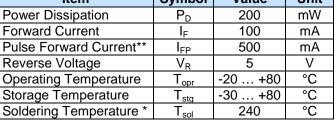
Structure: AlGaAs

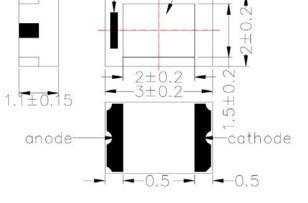
Peak Wavelength: typ. 735 nm Optical Output Power: typ. 10 mW

Package: Ceramic SMD, silicone / epoxy resin

Absolute Maximum Ratings ($T_a=25$ °C)

| Item | Symbol | Value | Unit |
|-------------------------|------------------|---------|------|
| Power Dissipation | P_{D} | 200 | mW |
| Forward Current | I _F | 100 | mΑ |
| Pulse Forward Current** | I _{FP} | 500 | mΑ |
| Reverse Voltage | V_R | 5 | V |
| Operating Temperature | T_{opr} | -20 +80 | °C |
| Storage Temperature | T _{stg} | -30 +80 | ô |
| Soldering Temperature * | T_{sol} | 240 | °C |





(Unit: mm)

Electro-Optical Characteristics

| Item | Symbol | Condition | Min. | Тур. | Max. | Unit |
|-----------------------|------------------|-------------|------|------|------|-------|
| Forward Voltage | V_{F} | IF = 50 mA | - | 1.85 | 2.00 | V |
| Reverse Current | I _R | $V_R = 5 V$ | - | - | 10 | μA |
| Total Radiated Power* | Po | IF = 50 mA | 4.0 | 10.0 | - | mW |
| Radiation Intensity | I _E | IF = 50 mA | 2.0 | 5.0 | - | mW/sr |
| Peak Wavelength | λ_{P} | IF = 50 mA | ı | 735 | - | nm |
| Half Width | Δλ | IF = 50 mA | ı | 30 | - | nm |
| Viewing Half Angle | Θ _{1/2} | IF = 50 mA | ı | ±55 | - | deg. |
| Rise Time | t_R | IF = 50 mA | | 80 | | ns |
| Fall Time | t _F | IF = 50 mA | | 80 | | ns |

^{*} Total Radiated Power is measured by Photodyne #500

Notes

- Do not view directly into the emitting area of the LED during operation!
- The above specifications are for reference purpose only and subjected to change without prior notice.

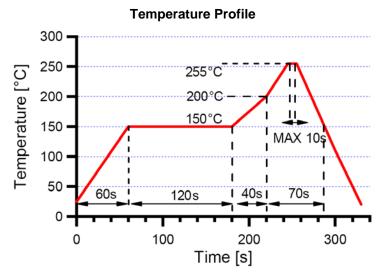


^{*} must be completed within 5 seconds
** max duty cycle 1%, max puls width 10µs

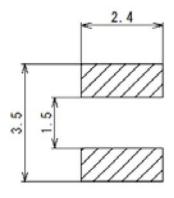


Soldering Conditions

- DO NOT apply any stress to the lead particularly when heat.
- After soldering the LEDs should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.



PCB Footprint Layout



(Unit: mm)

Static Electricity

- LEDs are very sensitive to Static Electricity and surge voltage. It is recommended to always wear a wrist band or an anti-electrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be grounded properly. It is recommended that precautions should be taken against surge voltage to the equipment that mounts the LEDs.